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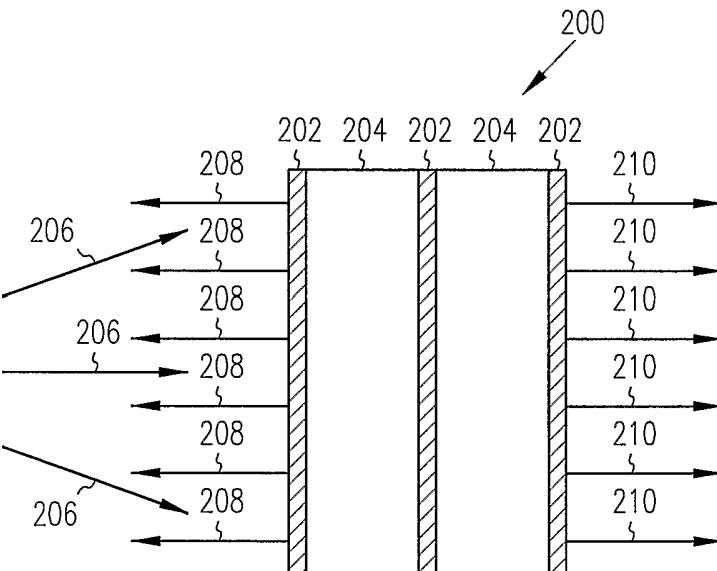
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(54) Title: MILLIMETER-WAVE TRANSREFLECTOR AND SYSTEM FOR GENERATING A COLLIMATED COHERENT WAVEFRONT



wavefront comprising the cross-polarized components may be produced in a second direction.

(57) Abstract: A planar multi-layer transreflector (200) for generating collimated coherent energy comprises one or more of insulating layers (204) between two or more metallic layers (202) disposed on the insulating layers (204). The transreflector (200) substantially reflects a cross-polarized component of an incident millimeter-wave signal (206) and substantially transmits remaining portions (210) of the incident millimeter-wave signal (206). Each of the metallic layers (202) comprises a plurality of rectangles arranged in a grid pattern radially varying in size within circumferential regions. The reflected cross-polarized component is substantially orthogonal to the transmitted remaining portions (210). A substantially collimated and coherent wavefront comprising the remaining portions (210) is produced in a first direction, and substantially collimated and coherent

MILLIMETER-WAVE TRANSREFLECTOR AND SYSTEM FOR
GENERATING A COLLIMATED COHERENT WAVEFRONT

Technical Field

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Some embodiments of the present invention pertain to millimeter-wave systems. Some embodiments relate to the generation of coherent energy.

Background

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Conventional techniques for concentrating, collimating and/or focusing microwave and millimeter-wave energy generally use curved surfaces and apply optical theory. To generate coherent energy having a single polarization, dielectric lenses, such as a Lundberg lens, have been used. These lenses are complex and 15 difficult to construct. Furthermore, it is difficult to generate sufficiently coherent and/or collimated energy for some applications with these conventional lenses.

Thus there are general needs for improved apparatus and methods that provide for concentrating, collimating and/or focusing microwave and millimeter-wave energy.

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Summary

A planar multi-layer transreflector for generating collimated coherent energy comprises one or more of insulating layers between two or more metallic 25 layers disposed on the insulating layers. The transreflector substantially reflects a cross-polarized component of an incident millimeter-wave signal and substantially transmits remaining portions of the incident millimeter-wave signal. Each of the metallic layers comprises a plurality of rectangles arranged in a grid pattern radially varying in size within circumferential regions. A substantially 30 collimated and coherent wavefront comprising the remaining portions is produced.

Brief Description of the Drawings

FIG. 1 is an illustration of a millimeter-wave collimated coherent wavefront generating system in accordance with some embodiments of the present invention;

5 FIG. 2A illustrates a side view of a multilayer transreflector in accordance with some embodiments of the present invention;

FIG. 2B illustrates a top view of a metallic layer of the transreflector of FIG. 2A;

10 FIG. 3 illustrates an array element of an amplifier array suitable for use with some embodiments of the present invention;

FIG. 4 illustrates an equivalent circuit for a multilayer transreflector in accordance with some embodiments of the present invention;

15 FIGs. 5A and 5B illustrates example of plots of four susceptance values that result in a preselected reflection phase; and

FIG. 6 is an example of a plot of phase variation across a center of a multilayer transreflector in accordance with some embodiments of the present invention.

Detailed Description

20

The following description and the drawings illustrate specific embodiments of the invention sufficiently to enable those skilled in the art to practice them. Other embodiments may incorporate structural, logical, electrical, process, and other changes. Examples merely typify possible variations.

25 Individual components and functions are optional unless explicitly required, and the sequence of operations may vary. Portions and features of some embodiments may be included in or substituted for those of others. Embodiments of the invention set forth in the claims encompass all available equivalents of those claims. Embodiments of the invention may be referred to, individually or
30 collectively, herein by the term "invention" merely for convenience and without intending to limit the scope of this application to any single invention or inventive concept if more than one is in fact disclosed.

FIG. 1 is an illustration of a millimeter-wave collimated coherent wavefront generating system in accordance with some embodiments of the present invention. Millimeter-wave collimated coherent wavefront generating system 100 may be used for generating collimated coherent millimeter-wave energy and may

5 comprise planar multilayer transreflector 102 and millimeter-wave source 104. Millimeter-wave source 104 may be positioned at a focus of transreflector 102 and may provide incident millimeter-wave signal 106. Multilayer transreflector 102 may substantially reflect cross-polarized component 108 of incident millimeter-wave signal 106 and may substantially transmit remaining portions

10 110 of incident millimeter-wave signal 106 to generate collimated coherent millimeter-wave wavefront 112. In these embodiments, cross-polarized component 108 may be substantially orthogonal to the polarization of incident millimeter-wave signal 106 and may substantially transmit remaining portions 110 of incident millimeter-wave signal 106.

15 In some embodiments, multilayer transreflector 102 may comprise a plurality of insulating layers arranged between metallic layers. The metallic layers each may comprise a plurality of rectangles arranged in a grid pattern that may vary radially within circumferential regions to allow multilayer transreflector 102 to substantially reflect cross-polarized component 108 of incident millimeter-wave signal 106 and to substantially transmit remaining portions 110 of incident millimeter-wave signal 106. Remaining portions 110 may include a cross-polarized component as well as a co-polarized component of incident millimeter-wave signal 106. Embodiments of this are described in more detail below.

20 Although some embodiments are described herein as substantially reflecting a cross-polarized (i.e., orthogonal) component, the scope of the invention is not limited in this respect. Other embodiments of the present invention may reflect a co-polarized component (i.e., having the same polarization) of incident millimeter-wave signal 106 and may transmit the remaining portions.

25 In some embodiments, source 104 may comprise a microwave or millimeter-wave amplifier array with orthogonally polarized input and output antennas to receive reflected cross-polarized component 108 and transmit co-polarized incident millimeter-wave signal 106. Example embodiments of this are

discussed in more detail below. In other embodiments, source 104 may be a microwave or millimeter-wave point source, although the scope of the invention is not limited in this respect.

FIG. 2A illustrates a side view of a multilayer transreflector in accordance with some embodiments of the present invention. FIG. 2B illustrates a top view of a metallic layer of the multilayer transreflector of FIG. 2A including an exploded view of a portion of the metallic layer. Multilayer transreflector 200 may be suitable for use as transreflector 102 (FIG. 1) although other transreflectors may also be used. Transreflector 200 may comprise one or more insulating layers 204 and metallic layers 202 disposed on the one or more insulating layers 204. This combination may substantially reflect cross-polarized component 208 of incident millimeter-wave signal 206 and may substantially transmit remaining portions 210 of incident millimeter-wave signal 206. In some embodiments, reflected cross-polarized components 208 may be a substantially collimated and a substantially coherent wavefront. In some embodiments, transmitted remaining portions 210 may be a substantially collimated and a substantially coherent wavefront.

As illustrated in FIG. 2B, metallic layer 202 may comprise a plurality of rectangles 212 arranged in a grid pattern. The size of rectangles 212 may radially vary in size within each of circumferential regions 216 (i.e., rings).

In some embodiments, the plurality of rectangles 212 may vary in size radially outward from larger to smaller within each of circumferential regions 216. In some other embodiments, the plurality of rectangles 212 may vary in size radially outward from smaller to larger within each of circumferential regions 216. In some embodiments, rectangles 212 may be squares, although the scope of the invention is not limited in this respect. The plurality of rectangles 212 may be electrically coupled by connecting lines 218 in either an x-direction or a y-direction. In some embodiments, connecting lines 218 may provide inductive reflections for polarization along lines 218 and may provide capacitive reflections for polarization orthogonal to lines 218. In this way, remaining portions 210 may be substantially transmitted and cross-polarized component 208 of incident millimeter-wave signal 106 may be substantially reflected. The use of connecting lines 218 in both the x and y directions would inhibit this.

In some embodiments, multilayer transreflector 200 may comprise two metallic layers 202 and one insulating layer 204 between metallic layers 202. In some embodiments, multilayer transreflector 200 may comprise three metallic layers 202 and two insulating layers 204 between metallic layers 202. In some 5 two and three-metallic layer embodiments, each of metallic layers 202 may be substantially identical and/or symmetric. In some other three metallic-layer embodiments, the middle metallic layer may be different than the outer metallic layers. In some two-layer embodiments, the two metallic layers may be different. Differences between metallic layers 202 may include the radial spacing between 10 circumferential regions 216, size and variation of rectangles 212, the spacing between rectangles 212, and/or a width of connecting lines 218. The variation between layers 202 may be selected to transmit a substantially collimated and substantially coherent wavefront of remaining portions 210 that may be generated from the incident millimeter-wave signal 206. The variation between layers 202 15 may also be selected to reflect a substantially collimated and substantially coherent wavefront of cross-polarized components 208 that may be generated from the incident millimeter-wave signal 206.

In some embodiments, a radial spacing between circumferential regions 216, size and variation of the rectangles 212, a spacing between rectangles 212, a 20 width of connecting lines 218 and/or a thickness of insulating material 204 may be selected so that the grid pattern of the metallic layers together with the insulating layers may generate substantially collimated and substantially coherent wavefronts of reflected and transmitted polarizations, although the scope of the invention is not limited in this respect.

25 In some embodiments, transreflector 200 may be illuminated by a millimeter-wave point source 104 (FIG. 1) positioned at a focal point which may be focal distance 103 (FIG. 1) from transreflector 200. The focal point may be defined as a location in which the reflected and/or transmitted wavefront is collimated, although the scope of the invention is not limited in this respect.

30 In some embodiments, transreflector 200 may be substantially circular and the focal distance may be approximately equal to the diameter, although the scope of the invention is not limited in this respect. In other embodiments, transreflector 200 may be square or rectangular in shape, although other shapes are also

suitable. In these embodiments, metallic layers 202 may be arranged circularly; however insulating layers 204 may extend beyond the diameter of the metallic layer's area for coupling with structural components of the system.

5 In some embodiments, incident millimeter-wave signal 206 may be generated by millimeter-wave point source 104 (FIG. 1). In some embodiments, incident millimeter-wave signal 206 may either be right-hand or left-hand circularly polarized, although the scope of the invention is not limited in this respect.

10 In some embodiments, transreflector 200 may be positioned at 45 degrees with respect to incident millimeter-wave signal 206. In this situation, incident millimeter-wave signal 206 may have a polarization that is substantially 45 degrees with respect to the grid structure of transreflector 200. In some other embodiments, source 104 (FIG. 1) may be linearly polarized, while in other embodiments, source 104 (FIG. 1) may be either right or left hand circularly 15 polarized, although the scope of the invention is not limited in this respect.

15 In some embodiments, circumferential regions 216 may vary radially from a center based on the relation: $k * \sqrt{r^2 + f^2}$ in which k is the wave number in radians per unit length, r is the radial distance from the center, and f is a focal distance. In this equation, k is the radian frequency in radians/sec divided by the 20 speed of light. In this way, the grid pattern of the metallic layers may have a radial dependence and no azimuth dependence. In some embodiments, the grid pattern may be fixed (i.e., the locations of the centers of the squares may be fixed) while the size of squares may be varied. In some embodiments, circumferential regions 216 (i.e., rings) may correspond to a particular reflection phase, although the 25 scope of the invention is not limited in this respect.

20 In some embodiments, insulating layer 204 comprises a microwave dielectric material, such as ceramic, quartz, Duroid, etc., although the scope of the invention is not limited in this respect. In some embodiments, metallic layer 202 may include conductive material such as copper, gold, silver, aluminum, etc. and 30 alloys thereof. In some embodiments, each metallic layer 202 may be deposited on one of insulating layers 204 using a process such as electroplating or sputtering. Photolithography, for example, may be used for the patterning of

metallic layer 202, although the scope of the invention is not limited in this respect.

FIG. 3 illustrates an array element of an amplifier array suitable for use with some embodiments of the present invention. The amplifier array may 5 comprise a plurality (e.g., up to several hundred or more) of array elements 302. The amplifier array may be suitable for use as a source, such as source 104 (FIG. 1) for generating incident millimeter-wave energy for collimation by transreflector 200 (FIG. 2), although the scope of the invention is not limited in this respect as point sources may also be suitable. The amplifier array may be referred to as a 10 reflect array.

In some embodiments, the amplifier array may be positioned at or near a focal point of transreflector 200 (FIG. 2) to receive reflected cross-polarized component 208 (FIG. 2). Each array element 302 may amplify the received cross-polarized component 208 (FIG. 2) and responsively transmit signals co-polarized 15 signals which are orthogonal to the received cross-polarized component.

In some embodiments, each array element 302 may comprise input antenna 304 having a first polarization to receive reflected cross-polarized component 208 (FIG. 2), millimeter-wave amplifier 306 to amplify the reflected cross-polarized component, and output antenna 308 coupled to an output of 20 amplifier 306. In some embodiments, output antenna 308 may have a polarization orthogonal to the polarization to input antenna 304 to transmit the signals orthogonal to the received cross-polarized component 208 (FIG. 2). As these co-polarized components are generated and transmitted by the array and as cross-polarized components 108 (FIG. 1) are reflected back from transreflector 102 25 (FIG. 1), the amplifiers of array elements 302 may oscillate at the desired millimeter-wave frequency allowing system 100 to generate wavefront 112 (FIG. 1).

In some embodiments, the amplifier array may receive collimated cross-polarized component 108 (FIG. 1), which may be a coherent wavefront allowing 30 the amplifier array to generate a coherent reflected wavefront comprising co-polarized components. In these embodiments, the amplifier array may be at least the same size as transreflector 102 (FIG. 1) to receive substantially the entire wavefront of collimated cross-polarized component 108 (FIG. 1).

In some other embodiments, output antenna 308 may have the same polarization as input antenna 304, although the scope of the invention is not limited in this respect.

In some embodiments, the pattern of metallic layers 202 (FIG. 2) may be viewed as aperiodic frequency selective structures (FSSs) in which the grid pattern may vary across the surface in such a way as to provide a particular reflection and transmission phase at each location on the surface. By adjusting the pattern across the surface, a desired reflection and transmission phase shift at every point may be produced which modifies the phase front on an incident wave to produce collimation. The following analysis may describe the scattering characteristics of the pattern so that it may be designed to produce the desired result.

For this analysis, it is assumed that transreflector 200 (FIG. 2) is electrically large so that the FSS characteristics change relatively slowly across the transreflector. This may be the case when the ratio of the diameter at the focal distance is close to unity. At each location on the surface, the scattering behavior may be approximated by the behavior of an infinite uniform periodic pattern. This may be repeated for each location across the transreflector. For this analysis, the transreflector's grid may be oriented at about 45 degrees with respect to the polarization of the source. The incident polarization may be resolved into two orthogonal components (herein referred to as principal axes) that lie along the grid axes. FIG. 4 shows the equivalent circuits for the structure with each circuit representing scattering in each of the two principal polarizations, referred to as horizontal and vertical polarizations. In FIG. 4, the shunt susceptances are chosen to provide desired reflection and transmission values and may vary across the surface to produce collimation. In this analysis of a three-metallic layer transreflector, the two outermost layers may be identical. This constraint may simplify the design and may help ensure focusing/collimation for both reflection and transmission simultaneously. The four port scattering matrix as seen from the source, which for this analysis is rotated 45 degrees with respect to the transreflector, has the form shown below due to symmetry and reciprocity.

$$S = \begin{pmatrix} S_{11} & S_{12} & T_{11} & T_{12} \\ S_{12} & S_{11} & T_{12} & T_{11} \\ T_{11} & T_{12} & S_{11} & S_{12} \\ T_{12} & T_{11} & S_{12} & S_{11} \end{pmatrix}$$

To obtain the desired characteristics, S_{11} should be zero for zero co-polarized reflection and $|S_{12}| = \alpha$ for a specific cross-polarized reflection. The 5 power not reflected may be transmitted through the transreflector as remaining portions 110 (FIG. 1) with a small fraction being absorbed by the losses in the structure. In addition, the susceptance values may be adjusted so that the phase of the reflection coefficient varies across the surface so that $\theta = \angle S_{12}$ may take on any desired value.

10 The dielectric constant and thickness of insulating layers 204 (FIG. 2) result in an equivalent transmission line characteristic admittance and electrical length equal to $Y_1 = Y_o \sqrt{\epsilon_r}$ and $\theta_i = 2\pi \sqrt{\epsilon_r} \frac{d}{\lambda \cos(\theta_i)}$ respectively, where $Y_o = \sqrt{377} \Omega$ is the admittance of free space, ϵ_r is the relative permittivity of the board material, d is the thickness of an insulating layer, and θ_i is the angle of incidence in which 15 zero degrees is normal incidence. Choosing a lower dielectric constant material may result in a narrower range of susceptance values that need to be realized simplifying the design process and possibly providing more robust results. In addition, values of insulating layer thickness close to a quarter wavelength for each insulating layer seem may provide better results, although the scope of the 20 invention is not limited in this respect.

Analysis of this transreflector structure provides the following values of frequency selective structure susceptances that may provide some desired characteristics:

$$25 \quad \begin{cases} B_1^v = Y_1 \cot(\theta_i) - Y_o \cot\left(\frac{1}{2}\left(\sin^{-1} \alpha - \theta + \frac{\pi}{2}\right)\right) \\ B_2^v = Y_1 \cot(\theta_i) \left(1 - \frac{Y_1}{Y_o \sin(2\theta_i)} \frac{\alpha + \cos(\theta)}{\sqrt{1 - \alpha^2}}\right) \end{cases}$$

$$\begin{cases} B_1^h = Y_1 \cot(\theta_i) + Y_o \tan\left(\frac{1}{2}\left(\sin^{-1} \alpha - \theta + \frac{\pi}{2}\right)\right) \\ B_2^h = Y_1 \cot(\theta_i) \left(1 - \frac{Y_1}{Y_o \sin(2\theta_i)} \frac{\alpha - \cos(\theta)}{\sqrt{1 - \alpha^2}}\right) \end{cases}$$

In some example embodiments, a dielectric material with a relative dielectric constant of 2.2 may be used for insulating layers 204 (FIG. 2). The 5 electrical thickness of each layer may be assumed to be 90 degrees for simplicity, although this value will change in practice due to the fact that the angle of incidence and the equivalent electrical thickness θ_i may vary across the surface. A value of $\alpha = 0.316$ may be chosen to produce 10% reflected power as cross-polarized component 108 (FIG. 1). FIGs. 5A and 5B show the values for the four 10 susceptances that produce a given reflection phase θ . Reference designation 502 corresponds to susceptance B_1^h , reference designation 504 corresponds to susceptance B_1^v , reference designation 506 corresponds to susceptance B_2^h , and reference designation 508 corresponds to susceptance B_2^v in the above equations. These plots may be used to determine the patterns across the surface of the 15 transreflector, as described below. The resulting four port scattering matrix magnitudes, as seen from the source, may be described as follows:

$$|S| = \begin{pmatrix} 0 & 0.316 & 0 & 0.949 \\ 0.316 & 0 & 0.949 & 0 \\ 0 & 0.949 & 0 & 0.316 \\ 0.949 & 0 & 0.316 & 0 \end{pmatrix}.$$

20 In this way, $\angle S_{12} = \theta$ and the angle of the transmission coefficient may be $\angle T_{12} = \theta + \frac{\pi}{2}$. This may help ensure that collimation of the reflected waves may also result in collimation of the transmitted waves.

The example plots illustrated in FIGs. 5A and 5B may be used to design a 25 collimating transreflector in the following way. After choosing a suitable diameter and focal length, a source (with diameter D_o) may be placed at the focal point and the phase of the incident field may be determined at the transreflector's surface. For a Gaussian beam source with a beam waist located at a distance z behind the

transreflector, the phase fronts on the surface may be described by the following equation:

$$\theta_i(r) = -2\pi \frac{z}{\lambda} \left(1 + \frac{1}{2} \frac{r^2}{z^2 + \left(\frac{\pi D_o^2}{4\lambda} \right)^2} \right).$$

5

An example of the phase variation is plotted in FIG. 6. The independent variable in the plot is the radial direction from the transreflector center in wavelengths. A transreflector that reflects and transmits with the negative of this phase distribution (i.e., $\angle S_{12} = -\theta_i(r)$) may collimate both the reflected and 10 transmitted beams.

After specifying the phase distribution, FSS cells may be designed that produce the desired scattering. A suitable electromagnetic code may be used for this purpose, such as Ansoft's HFSS code, or a Method of Moments code. First, a unit cell size is chosen. In practice, smaller unit cells may give more robust 15 results, but a too small cell size may limit the realizable susceptance values. In some embodiments, a unit cell size of $\sim 0.4\lambda$ may be sufficient. The surface may be divided into a grid of unit cells and the average phase of each cell may be given by $-\theta_i(r)$ above. From the phase at each location, the desired susceptances may be determined using the equations above. The two outer metallic layers, for 20 example, may be designed using the electromagnetic code to provide the desired susceptance values.

Thus, a planar multi-layer transreflector, a system and a design method have been described for generating collimated coherent energy. In some embodiments, the transreflector comprises one or more of insulating layers 25 between two or more metallic layers. In some embodiments, the transreflector substantially reflects a cross-polarized component of an incident millimeter-wave signal and substantially transmits remaining portions of the incident millimeter-wave signal. The reflected cross-polarized component may be amplified by a reflective array of amplifiers which transmit a co-polarized incident signal.

The Abstract is provided to comply with 37 C.F.R. Section 1.72(b) requiring an abstract that will allow the reader to ascertain the nature and gist of the technical disclosure. It is submitted with the understanding that it will not be used to limit or interpret the scope or meaning of the claims.

5 In the foregoing detailed description, various features are occasionally grouped together in a single embodiment for the purpose of streamlining the disclosure. This method of disclosure is not to be interpreted as reflecting an intention that the claimed embodiments of the subject matter require more features than are expressly recited in each claim. Rather, as the following claims 10 reflect, invention may lie in less than all features of a single disclosed embodiment. Thus the following claims are hereby incorporated into the detailed description, with each claim standing on its own as a separate preferred embodiment.

CLAIMS

What is claimed is:

- 1 1. A planar multi-layer transreflector (200) for generating collimated
2 coherent energy comprising:
3 an insulating layer (204); and
4 a metallic layer (202) disposed on the insulating layer (204) to
5 substantially reflect a first portion of an incident millimeter-wave signal (206) and
6 substantially transmit through the transreflector remaining portions of the incident
7 millimeter-wave signal (206),
8 wherein the metallic layer (202) comprises a plurality of rectangles (212)
9 arranged in a grid pattern radially varying in size within circumferential regions
10 (216),
11 wherein the first portion has a polarization substantially orthogonal to the
12 incident millimeter-wave signal.

- 1 2. The transreflector of claim 1 wherein the plurality of rectangles (212)
2 vary in size radially outward from larger to smaller within each of the
3 circumferential regions (216), and
4 wherein the plurality of rectangles (212) are electrically coupled by
5 connecting lines (218) in either an x-direction or a y-direction to substantially
6 reflect the first portion.

- 1 3. The transreflector of claim 2 wherein the metallic layer (202) is one of
2 three metallic layers (202), and
3 wherein the insulating layer (204) is one of two insulating layers (204)
4 disposed between the metallic layers (202).

- 1 4. The transreflector of claim 3 wherein the first component comprises
2 cross-polarized components of the incident millimeter wave signal (206), and
3 wherein a radial spacing between the circumferential regions (216), size
4 and variation of the rectangles (212), a spacing between the rectangles (212), and

5 a width of the connecting lines (218) are selected to generate a substantially
6 collimated and substantially coherent wavefront (112) of the remaining portions
7 (210) from the incident millimeter-wave signal (206) and to generate a
8 substantially collimated and substantially coherent wavefront of the cross-
9 polarized components.

1 5. A planar multi-layer transreflector (200) for generating collimated
2 coherent energy comprising:

3 three metallic layers (202), each having a plurality of rectangles (212)
4 arranged in a grid pattern radially varying in size within each of a plurality of
5 circumferential regions (216); and

6 two insulating layers (204), each disposed between two of the metallic
7 layers (202),

8 wherein the plurality of rectangles (212) are electrically coupled by
9 connecting lines (218) in either an x-direction or a y-direction.

1 6. The planar transreflector of claim 5 wherein the plurality of rectangles
2 (212) arranged in a grid pattern radially varying in size from larger to smaller
3 within each of the circumferential regions (216).

1 7. The planar transreflector of claim 6 wherein cross-polarized
2 components of an incident millimeter-wave signal (206) is substantially reflected
3 in a collimated coherent wavefront,

4 wherein remaining portions (210) of the incident millimeter-wave signal
5 (206) are substantially transmitted through the transreflector in a collimated
6 coherent wavefront,

7 wherein the reflected cross-polarized components of the incident
8 millimeter-wave signal (206) are substantially orthogonal to the transmitted
9 remaining portions (210) of the incident millimeter-wave signal (206), and

10 wherein the remaining portions (210) comprises a substantially collimated
11 and coherent wavefront (112).

1 8. The transreflector of claim 7 wherein radial spacing between the
2 circumferential regions (216), size and variation of the rectangles (212), a spacing
3 between the rectangles (212), and a width of the connecting lines (218) are
4 selected to generate a substantially collimated and substantially coherent
5 wavefront (112) of the remaining portions (210) from the incident millimeter-
6 wave signal (206) and to generate a substantially collimated and substantially
7 coherent wavefront of the cross-polarized components.

1 9. A system (100) for generating collimated coherent millimeter-wave
2 energy comprising:

3 a planar multilayer transreflector (102) comprising a plurality of insulating
4 layers (204) arranged between metallic layers (202); and

5 a millimeter-wave source (104) positioned at a focus of the transreflector
6 (102) to provide an incident millimeter-wave signal (106),

7 wherein the metallic layers (202) each comprise a plurality of rectangles
8 (212) arranged in a grid pattern radially varying in size within circumferential
9 regions (216) to allow the multilayer transreflector (102) to substantially reflect a
10 first component of the incident millimeter-wave signal (206) and to substantially
11 transmit remaining portions (210) of the incident millimeter-wave signal (206)
12 through the transreflector, and

13 wherein the first component has a polarization substantially orthogonal to
14 the incident millimeter-wave signal.

1 10. The system of claim 9 wherein the plurality of rectangles (212) vary in
2 size radially outward within each of the circumferential regions (216), and

3 wherein the plurality of rectangles (212) are electrically coupled by
4 connecting lines (218) in either an x-direction or a y-direction,

5 wherein the first component comprises cross-polarized components of the
6 incident millimeter wave signal (206),

7 wherein the remaining portions (210) comprise a substantially collimated
8 and coherent wavefront (110) in a first direction,

9 wherein the cross-polarized components 108 comprise a substantially
10 collimated and coherent wavefront (110) in a second direction,

- 11 wherein the metallic layer (202) is one of three metallic layers (202), and
- 12 wherein the insulating layer (204) is one of two insulating layers (204)
- 13 disposed between the metallic layers (202).

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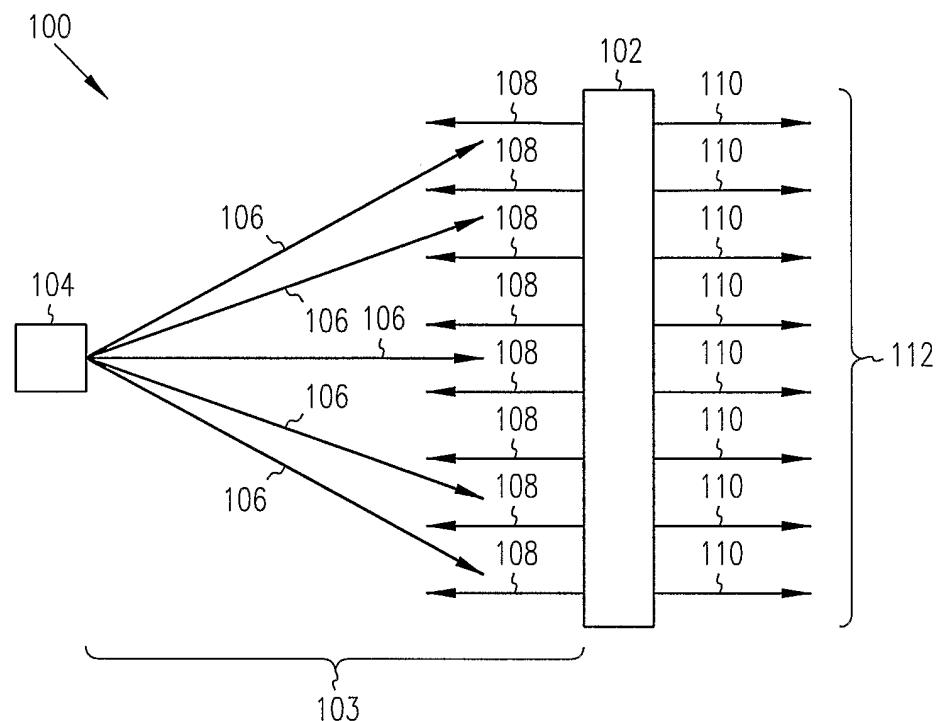


FIG. 1

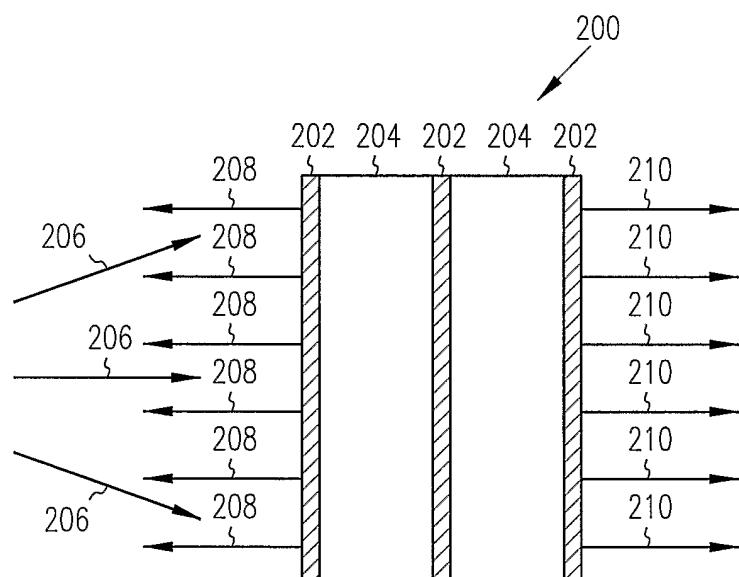


FIG. 2A

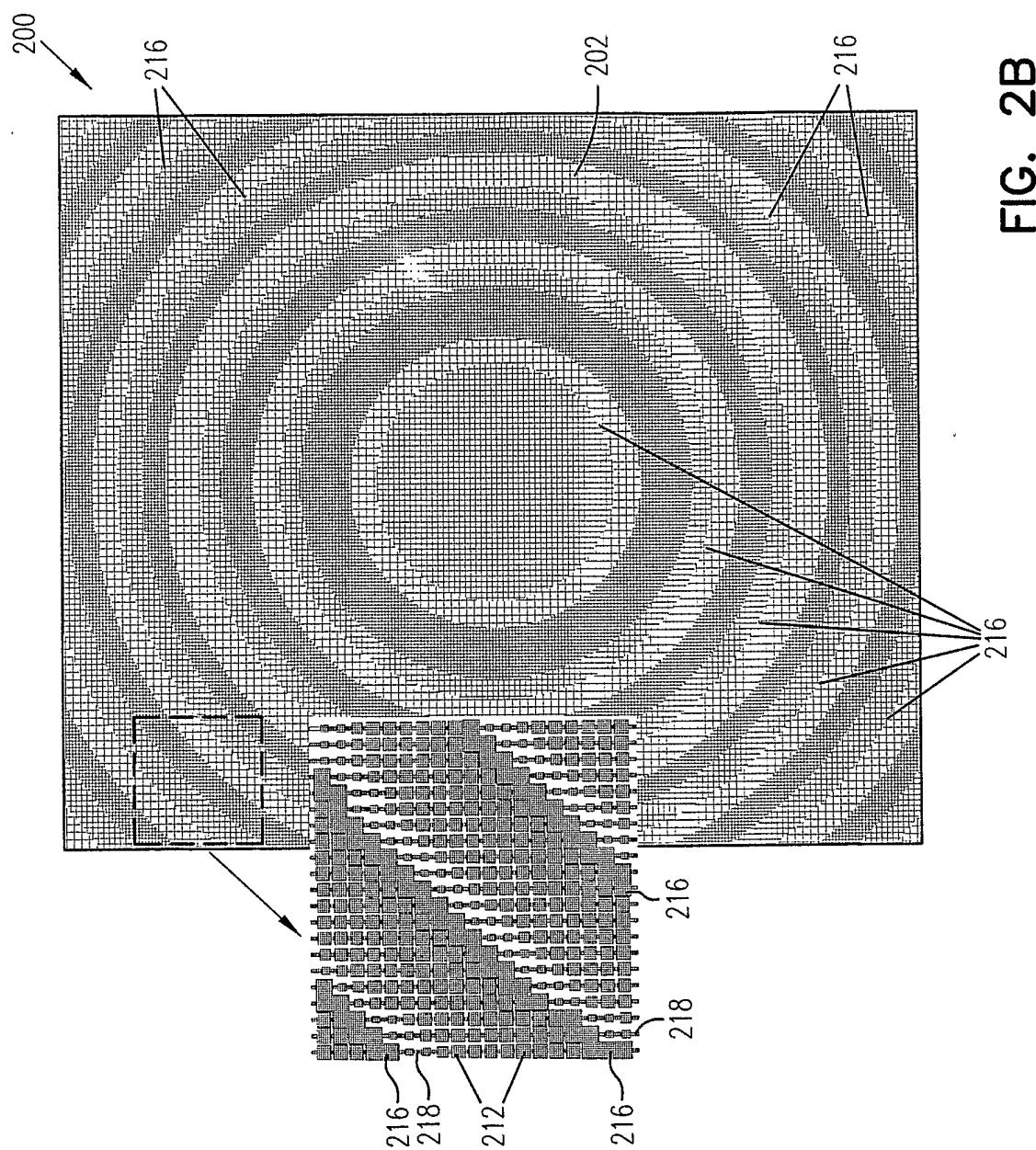


FIG. 2B

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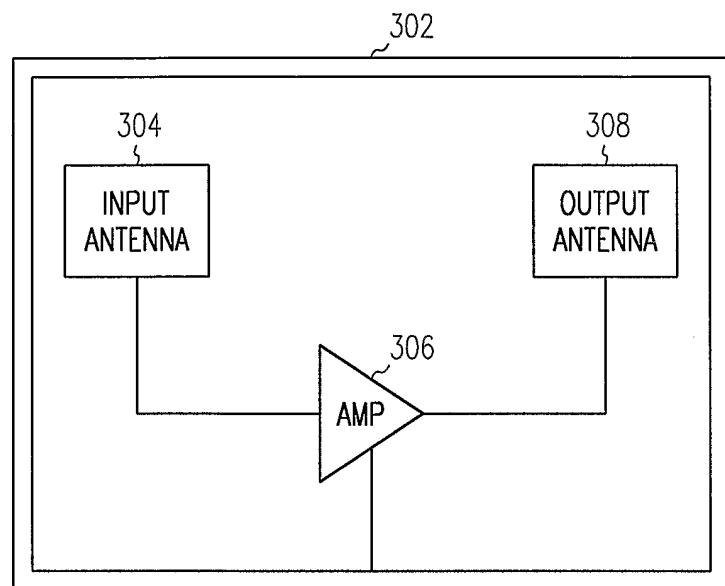


FIG. 3

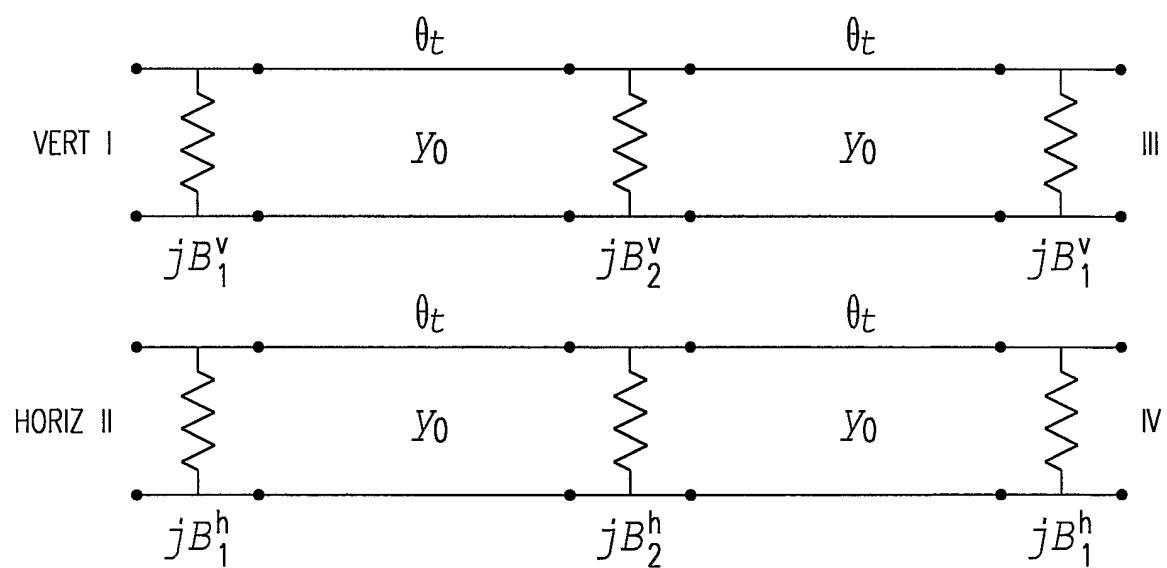


FIG. 4

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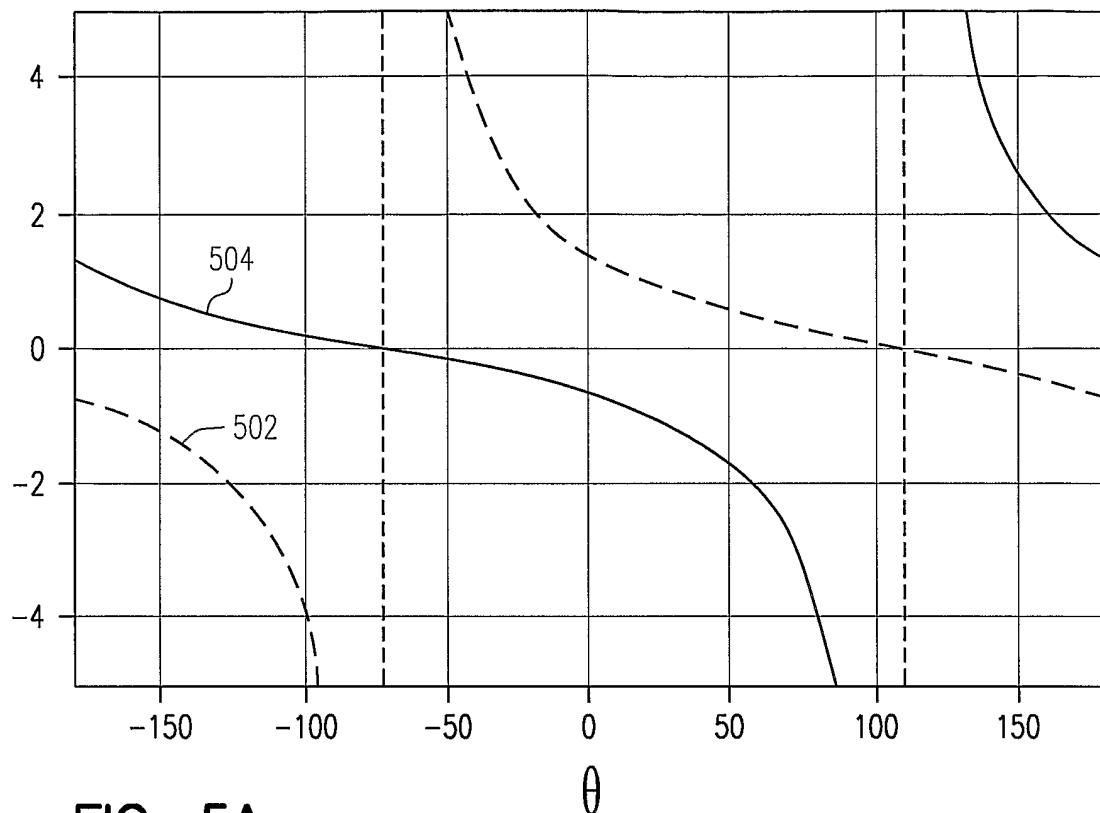


FIG. 5A

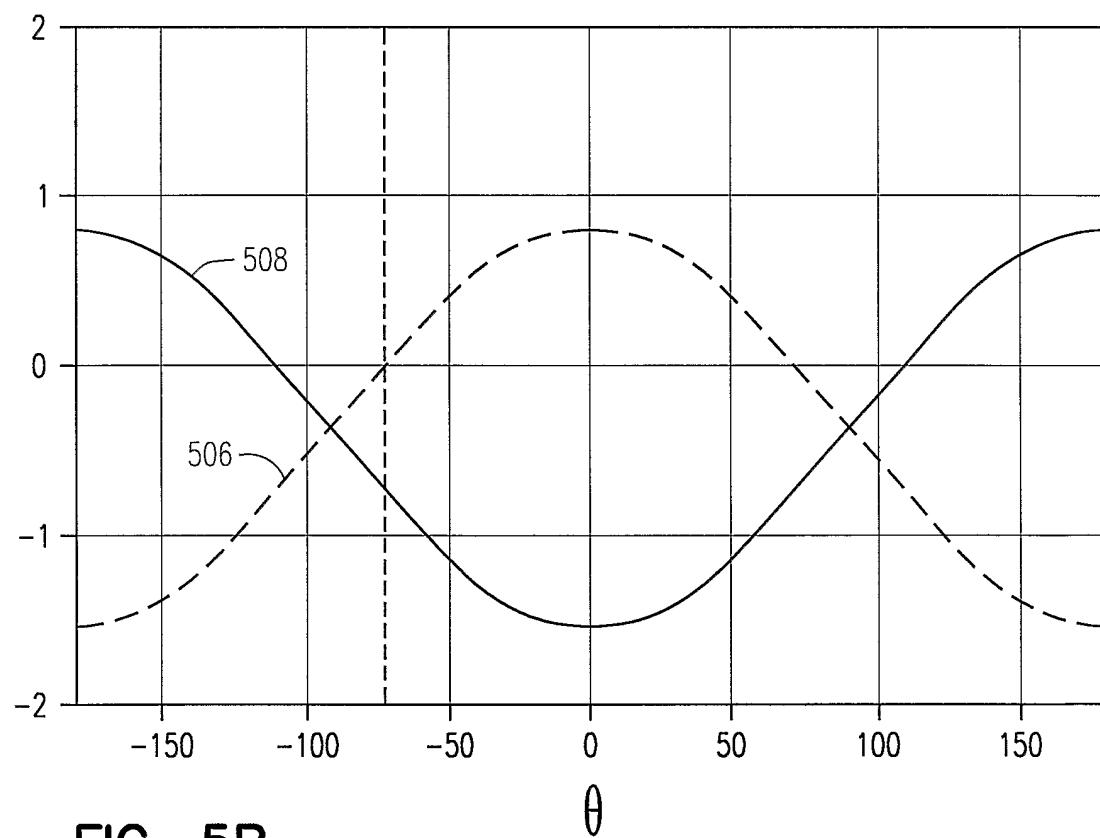


FIG. 5B

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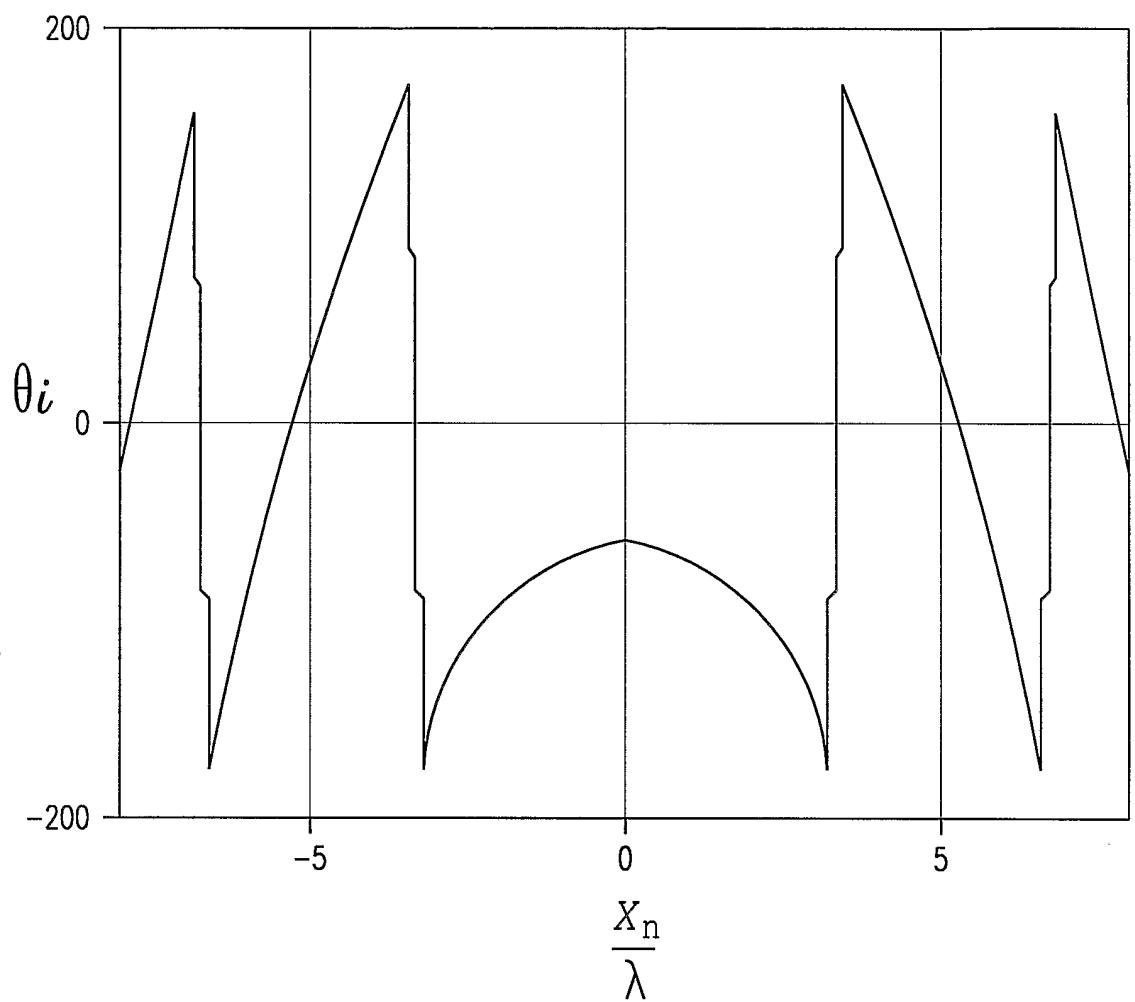


FIG. 6

INTERNATIONAL SEARCH REPORT

International application No
PCT/US2006/010127

A. CLASSIFICATION OF SUBJECT MATTER
INV. H01Q19/195
ADD. H01Q3/46

According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)
H01Q

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and, where practical, search terms used)

EPO-Internal, WPI Data, PAJ, INSPEC, COMPENDEX

C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
Y	US 3 276 023 A (DORNE ARTHUR ET AL) 27 September 1966 (1966-09-27) column 2, line 44 - column 5, line 41 column 8, line 10 - column 9, line 26 figures 1-3,8,9 -----	1-10
Y	EP 1 120 856 A (UNIVERSIDAD POLITECNICA DE MADRID) 1 August 2001 (2001-08-01) page 3, line 57 - page 9, line 28 figures 1-14 abstract -----	1-10
A	US 3 267 480 A (LERNER DAVID S) 16 August 1966 (1966-08-16) column 2, line 46 - column 5, line 15 figures 1a-4 ----- -/-	1-10

Further documents are listed in the continuation of Box C.

See patent family annex.

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Date of the actual completion of the international search	Date of mailing of the international search report
20 July 2006	26/07/2006
Name and mailing address of the ISA/ European Patent Office, P.B. 5818 Patentlaan 2 NL - 2280 HV Rijswijk Tel. (+31-70) 340-2040, Tx. 31 651 epo nl, Fax: (+31-70) 340-3016	Authorized officer von Walter, S-U

INTERNATIONAL SEARCH REPORT

International application No
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C(Continuation). DOCUMENTS CONSIDERED TO BE RELEVANT

Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
A	US 2004/196193 A1 (BROWN KENNETH W ET AL) 7 October 2004 (2004-10-07) page 2, paragraph 33 – page 3, paragraph 49 figures 1-3 -----	1-10

INTERNATIONAL SEARCH REPORT

Information on patent family members

International application No

PCT/US2006/010127

Patent document cited in search report	Publication date	Patent family member(s)			Publication date
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EP 1120856	A 01-08-2001	AT 324679 T	15-05-2006	WO 0076026 A1	14-12-2000
		ES 2153323 A1	16-02-2001		
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US 2004196193	A1 07-10-2004	US 6765535 B1	20-07-2004		